

2SC4410

Silicon NPN epitaxial planar type

For UHF amplification

■ Features

- Allowing the small current and low voltage operation
- High transition frequency f_T
- S-Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing

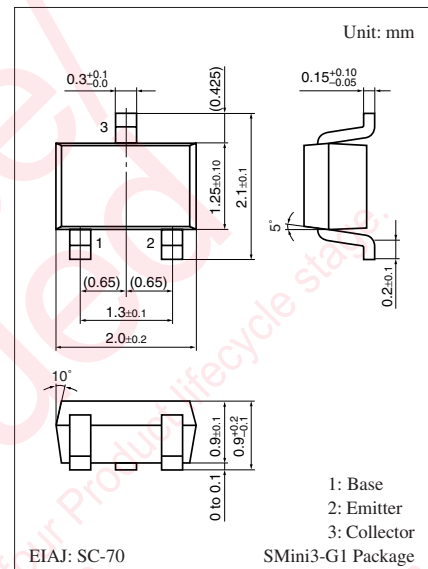
■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V_{CBO}	10	V
Collector-emitter voltage (Base open)	V_{CEO}	7	V
Emitter-base voltage (Collector open)	V_{EBO}	2	V
Collector current	I_C	10	mA
Collector power dissipation	P_C	50	mW
Junction temperature	T_j	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

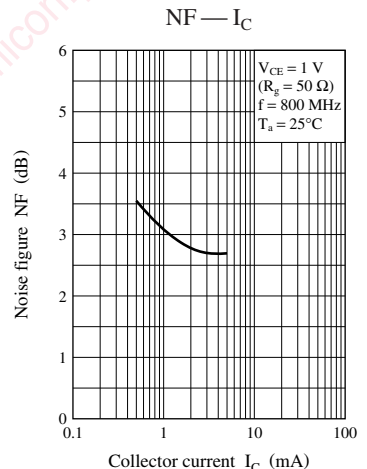
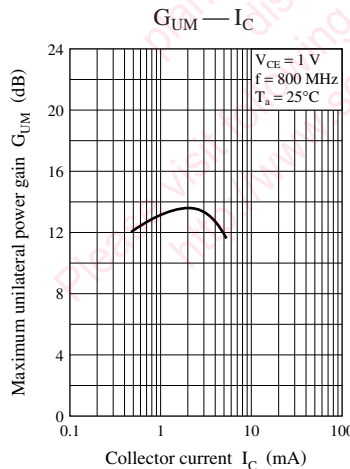
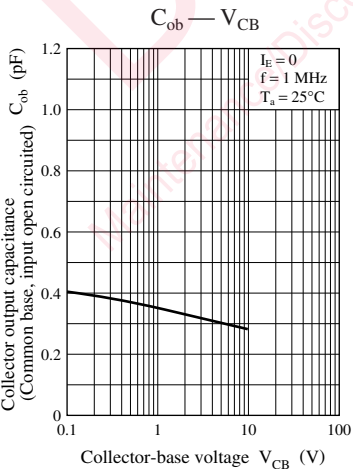
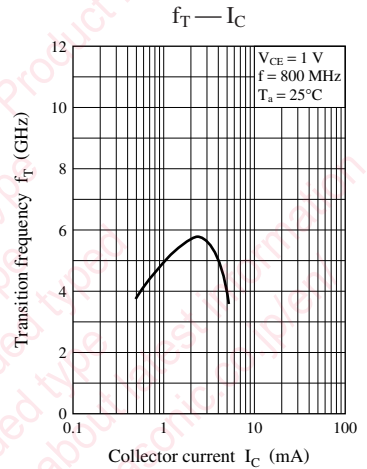
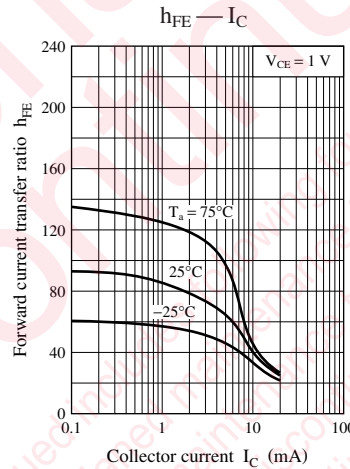
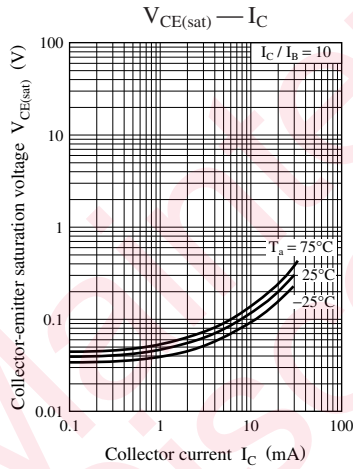
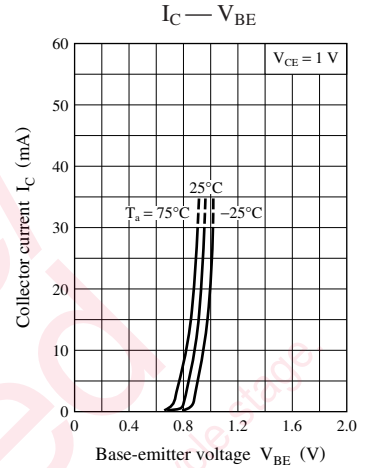
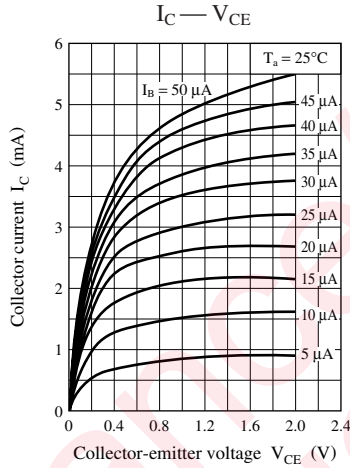
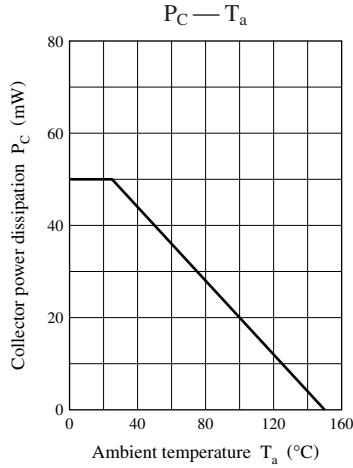
■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-base cutoff current (Emitter open)	I_{CBO}	$V_{CB} = 10\text{ V}, I_E = 0$			1	μA
Emitter-base cutoff current (Collector open)	I_{EBO}	$V_{EB} = 1.5\text{ V}, I_C = 0$			1	μA
Forward current transfer ratio	h_{FE}	$V_{CE} = 1\text{ V}, I_C = 1\text{ mA}$	50		200	—
Transition frequency	f_T	$V_{CE} = 1\text{ V}, I_C = 1\text{ mA}, f = 0.8\text{ GHz}$		4		GHz
Collector output capacitance (Common base, input open circuited)	C_{ob}	$V_{CB} = 1\text{ V}, I_E = 0, f = 1\text{ MHz}$		0.4		pF
Forward transfer gain	$ S_{21e} ^2$	$V_{CE} = 1\text{ V}, I_C = 1\text{ mA}, f = 0.8\text{ GHz}$		6.0		dB
Maximum unilateral power gain	G_{UM}	$V_{CE} = 1\text{ V}, I_C = 1\text{ mA}, f = 0.8\text{ GHz}$		15		dB
Noise figure	NF	$V_{CE} = 1\text{ V}, I_C = 1\text{ mA}, f = 0.8\text{ GHz}$		3.5		dB

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.
2. Handle the product with care because this is sensitive to the electrostatic breakdown by its structure



Marking Symbol: 2X



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